

International  
**IOR** Rectifier

## ST110S SERIES

**PHASE CONTROL THYRISTORS**

**Stud Version**

### Features

- Center gate
- Hermetic metal case with ceramic insulator (Glass-metal seal over 1200V)
- International standard case TO-209AC (TO-94)
- Compression Bonded Encapsulation for heavy duty operations such as severe thermal cycling

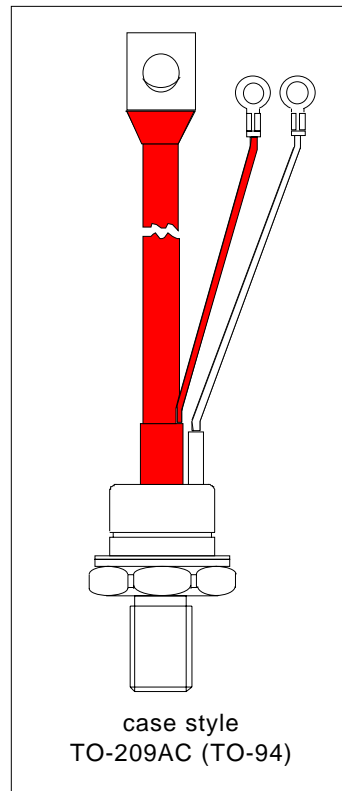
110A

### Typical Applications

- DC motor controls
- Controlled DC power supplies
- AC controllers

### Major Ratings and Characteristics

Parameters	ST110S	Units
$I_{T(AV)}$	110	A
@ $T_C$	90	°C
$I_{T(RMS)}$	175	A
$I_{TSM}$ @ 50Hz	2700	A
@ 60Hz	2830	A
$I^2t$ @ 50Hz	36.4	KA <sup>2</sup> s
@ 60Hz	33.2	KA <sup>2</sup> s
$V_{DRM}/V_{RRM}$	400 to 1600	V
$t_q$ typical	100	μs
$T_J$	- 40 to 125	°C



## ST110S Series

Bulletin I25167 rev. C 03/03

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### ELECTRICAL SPECIFICATIONS

#### Voltage Ratings

Type number	Voltage Code	$V_{DRM}/V_{RRM}$ , max. repetitive peak and off-state voltage V	$V_{RSM}$ , maximum non-repetitive peak voltage V	$I_{DRM}/I_{RRM}$ max. @ $T_J = T_J \text{ max}$ mA
ST110S	04	400	500	20
	08	800	900	
	12	1200	1300	
	16	1600	1700	

#### On-state Conduction

Parameter		ST110S	Units	Conditions			
I <sub>T(AV)</sub>	Max. average on-state current @ Case temperature	110	A	180° conduction, half sine wave			
		90	°C				
I <sub>T(RMS)</sub>	Max. RMS on-state current	175	A	DC @ 85°C case temperature			
I <sub>TSM</sub>	Max. peak, one-cycle non-repetitive surge current	2700	A	t = 10ms	No voltage	Sinusoidal half wave, Initial T <sub>J</sub> = T <sub>J</sub> max.	
		2830		t = 8.3ms	reapplied		
		2270		t = 10ms	100% V <sub>RRM</sub>		
		2380		t = 8.3ms	reapplied		
I <sup>2</sup> t	Maximum I <sup>2</sup> t for fusing	36.4	KA <sup>2</sup> s	t = 10ms	No voltage		
		33.2		t = 8.3ms	reapplied		
		25.8		t = 10ms	100% V <sub>RRM</sub>		
		23.5		t = 8.3ms	reapplied		
I <sup>2</sup> √t	Maximum I <sup>2</sup> √t for fusing	364	KA <sup>2</sup> /s	t = 0.1 to 10ms, no voltage reapplied			
V <sub>T(TO)1</sub>	Low level value of threshold voltage	0.90	V	(16.7% × π × I <sub>T(AV)</sub> < I < π × I <sub>T(AV)</sub> ), T <sub>J</sub> = T <sub>J</sub> max.			
V <sub>T(TO)2</sub>	High level value of threshold voltage	0.92		(I > π × I <sub>T(AV)</sub> ), T <sub>J</sub> = T <sub>J</sub> max.			
r <sub>t1</sub>	Low level value of on-state slope resistance	1.79	mΩ	(16.7% × π × I <sub>T(AV)</sub> < I < π × I <sub>T(AV)</sub> ), T <sub>J</sub> = T <sub>J</sub> max.			
r <sub>t2</sub>	High level value of on-state slope resistance	1.81		(I > π × I <sub>T(AV)</sub> ), T <sub>J</sub> = T <sub>J</sub> max.			
V <sub>TM</sub>	Max. on-state voltage	1.52	V	I <sub>pk</sub> = 350A, T <sub>J</sub> = T <sub>J</sub> max, t <sub>p</sub> = 10ms sine pulse			
I <sub>H</sub>	Maximum holding current	600	mA	T <sub>J</sub> = 25°C, anode supply 12V resistive load			
I <sub>L</sub>	Typical latching current	1000					

#### Switching

Parameter	ST110S	Units	Conditions
$di/dt$ Max. non-repetitive rate of rise of turned-on current	500	A/μs	Gate drive 20V, 20Ω, $t_r \leq 1\mu s$ $T_J = T_J \text{ max}$ , anode voltage $\leq 80\% V_{DRM}$
$t_d$ Typical delay time	2.0	μs	Gate current 1A, $di_g/dt = 1A/\mu s$ $V_d = 0.67\% V_{DRM}, T_J = 25^\circ\text{C}$
$t_q$ Typical turn-off time	100		$I_{TM} = 100A, T_J = T_J \text{ max}, di/dt = 10A/\mu s, V_R = 50V$ $dv/dt = 20V/\mu s$ , Gate 0V 100Ω, $t_p = 500\mu s$

### Blocking

Parameter	ST110S	Units	Conditions
$dv/dt$ Maximum critical rate of rise of off-state voltage	500	V/ $\mu$ s	$T_J = T_J \text{ max. linear to } 80\% \text{ rated } V_{\text{DRM}}$
$I_{\text{RRM}}$ $I_{\text{DRM}}$ Max. peak reverse and off-state leakage current	20	mA	$T_J = T_J \text{ max, rated } V_{\text{DRM}}/V_{\text{RRM}}$ applied

### Triggering

Parameter	ST110S	Units	Conditions
$P_{\text{GM}}$ Maximum peak gate power	5	W	$T_J = T_J \text{ max, } t_p \leq 5\text{ms}$
$P_{\text{G(AV)}}$ Maximum average gate power	1		$T_J = T_J \text{ max, } f = 50\text{Hz, } d\% = 50$
$I_{\text{GM}}$ Max. peak positive gate current	2.0	A	$T_J = T_J \text{ max, } t_p \leq 5\text{ms}$
$+V_{\text{GM}}$ Maximum peak positive gate voltage	20	V	$T_J = T_J \text{ max, } t_p \leq 5\text{ms}$
$-V_{\text{GM}}$ Maximum peak negative gate voltage	5.0		
$I_{\text{GT}}$ DC gate current required to trigger	TYP.	MAX.	$T_J = -40^\circ\text{C}$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$ Max. required gate trigger/ current/ voltage are the lowest value which will trigger all units 12V anode-to-cathode applied
	180	-	
	90	150	
$V_{\text{GT}}$ DC gate voltage required to trigger	2.9	-	$T_J = -40^\circ\text{C}$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$
	1.8	3.0	
	1.2	-	
$I_{\text{GD}}$ DC gate current not to trigger	10	mA	$T_J = T_J \text{ max}$ Max. gate current/ voltage not to trigger is the max. value which will not trigger any unit with rated $V_{\text{DRM}}$ anode-to-cathode applied
$V_{\text{GD}}$ DC gate voltage not to trigger	0.25	V	

### Thermal and Mechanical Specification

Parameter	ST110S	Units	Conditions
$T_J$ Max. operating temperature range	-40 to 125	$^\circ\text{C}$	
$T_{\text{stg}}$ Max. storage temperature range	-40 to 150		
$R_{\text{thJC}}$ Max. thermal resistance, junction to case	0.195	K/W	DC operation
$R_{\text{thCS}}$ Max. thermal resistance, case to heatsink	0.08		Mounting surface, smooth, flat and greased
T Mounting torque, $\pm 10\%$	15.5	Nm (lbf-in)	Non lubricated threads
	(137)		
	14 (120)		Lubricated threads
wt Approximate weight	130	g	
Case style	TO-209AC (TO-94)		See Outline Table

ST110S Series

Bulletin I25167 rev. C 03/03

$\Delta R_{thJC}$  Conduction

(The following table shows the increment of thermal resistance  $R_{thJC}$  when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction	Rectangular conduction	Units	Conditions
180°	0.035	0.025	K/W	$T_J = T_{J \text{ max.}}$
120°	0.041	0.042		
90°	0.052	0.056		
60°	0.076	0.079		
30°	0.126	0.127		

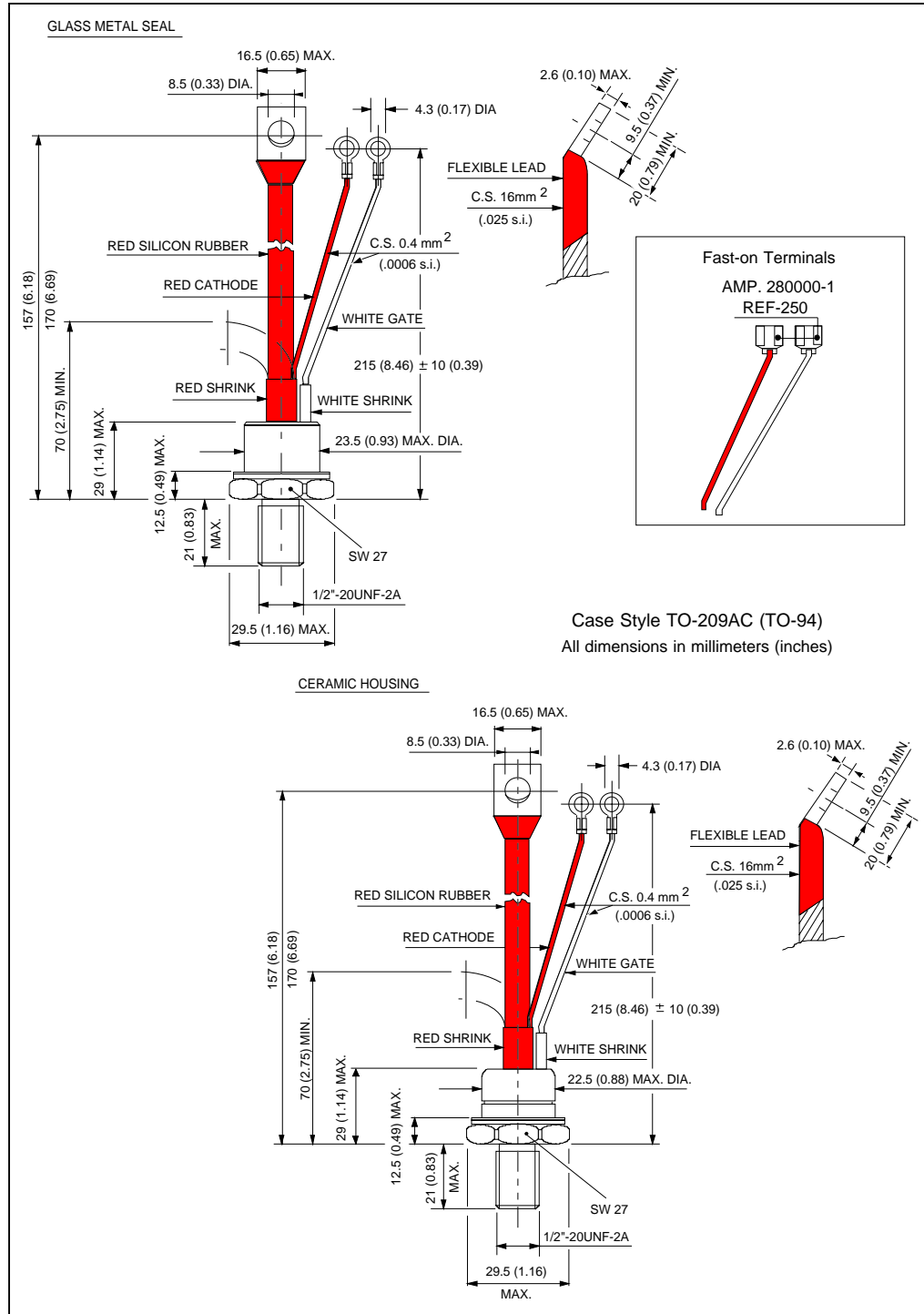
Ordering Information Table

Device Code

ST	11	0	S	16	P	0	V
1	2	3	4	5	6	7	8

- 1** - Thyristor
- 2** - Essential part number
- 3** - 0 = Converter grade
- 4** - S = Compression bonding Stud
- 5** - Voltage code: Code x 100 =  $V_{RRM}$  (See Voltage Rating Table)
- 6** - P = Stud base 1/2"-20UNF-2A threads
- 7** - 0 = Eyelet terminals (Gate and Auxiliary Cathode Leads)  
1 = Fast - on terminals (Gate and Auxiliary Cathode Leads)
- 8** - V = Glass-metal seal (only up to 1200V)  
None = Ceramic housing (over 1200V)

Outline Table



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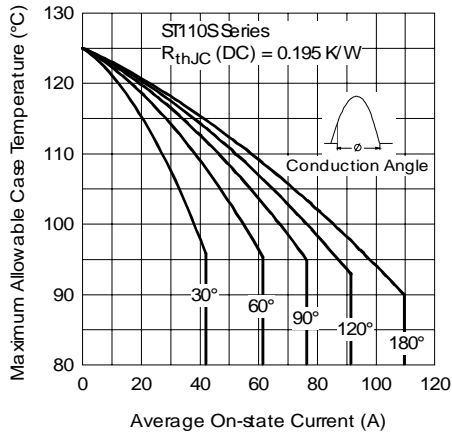


Fig. 1 - Current Ratings Characteristics

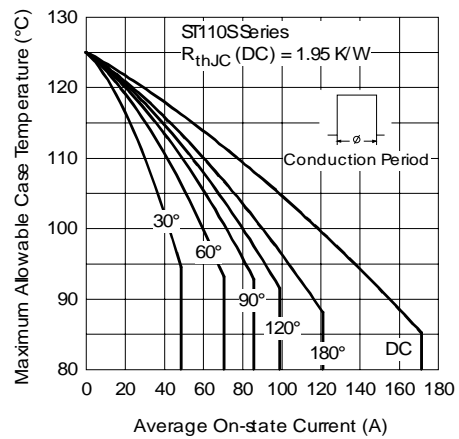


Fig. 2 - Current Ratings Characteristics

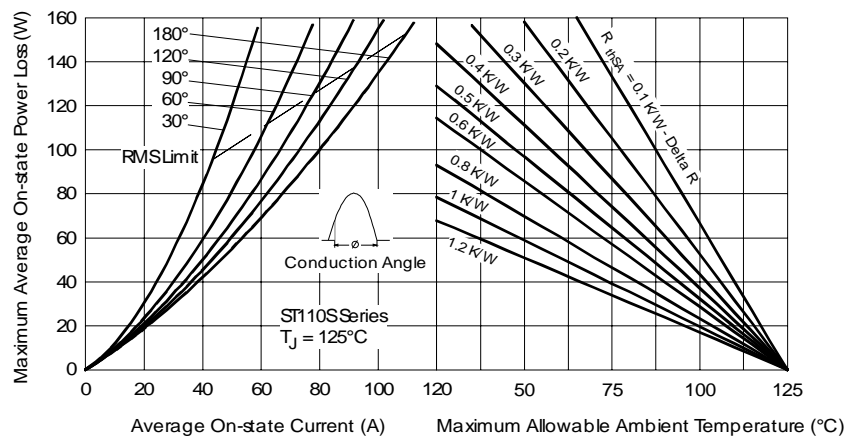


Fig. 3 - On-state Power Loss Characteristics

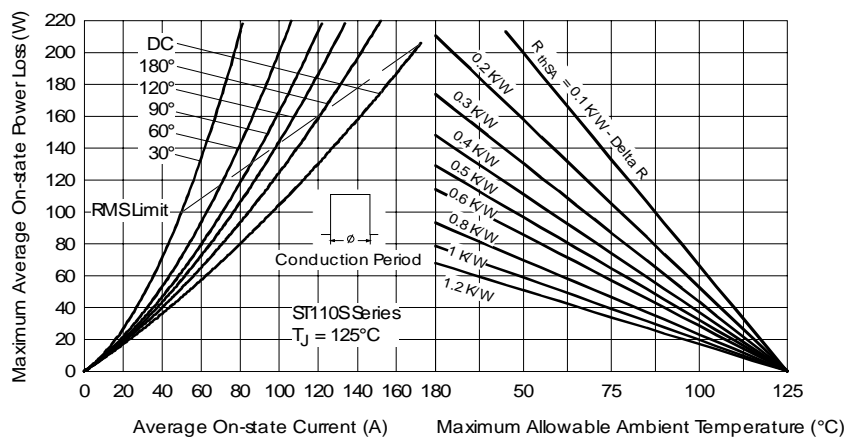


Fig. 4 - On-state Power Loss Characteristics

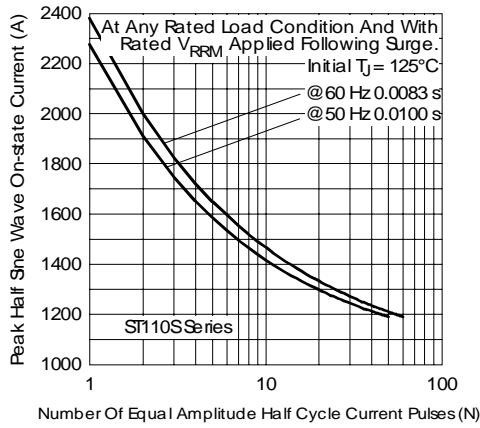


Fig. 5 - Maximum Non-Repetitive Surge Current

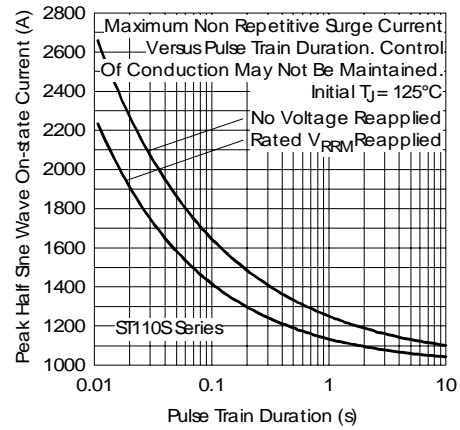


Fig. 6 - Maximum Non-Repetitive Surge Current

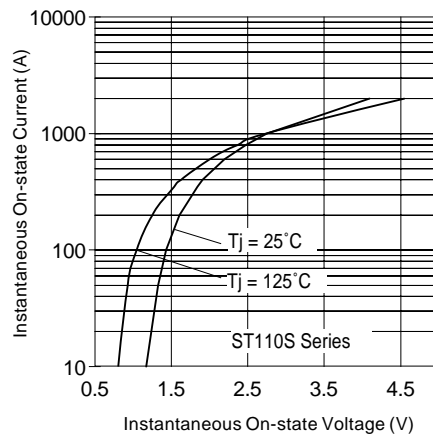


Fig. 7 - On-state Voltage Drop Characteristics

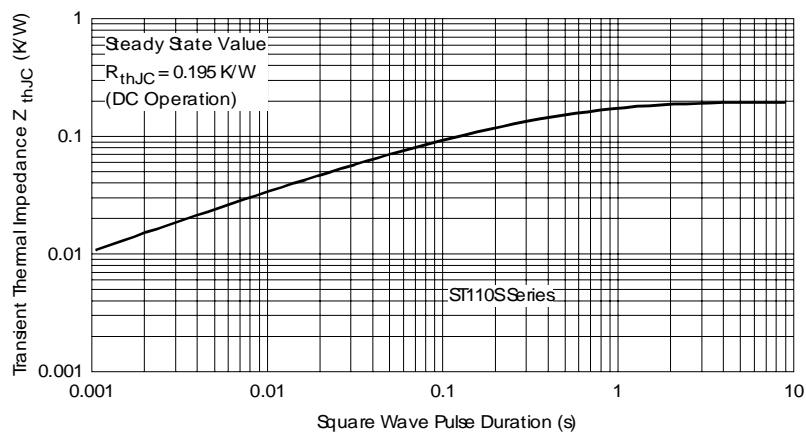


Fig. 8 - Thermal Impedance  $Z_{thJC}$  Characteristic

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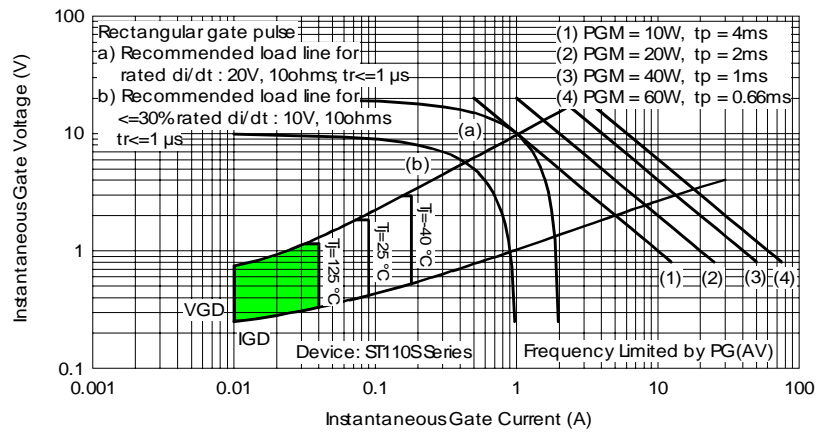


Fig. 9 - Gate Characteristics

Data and specifications subject to change without notice.  
This product has been designed and qualified for Industrial Level.  
Qualification Standards can be found on IR's Web site.

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